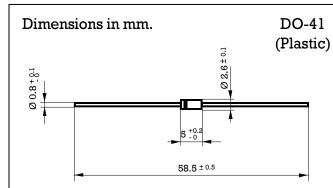


# 1 Amp. Glass Passivated Fast Recovery Rectifier



# Mounting instructions

- 1. Min. distance from body to soldering point, 4 mm.
- 2. Max. solder temperature, 350 °C.
- 3. Max. soldering time, 3.5 sec.
- 4. Do not bend lead at a point closer than 2 mm. to the body.

Voltage Current 50 to 1000 V. 1.0 A. at 55 °C.



## • Glass passivated junction

- High current capability
- The plastic material carries U/L recognition 94 V-0
- Terminals: Axial Leads
- Polarity: Color band denotes cathode

## Maximum Ratings, according to IEC publication No. 134

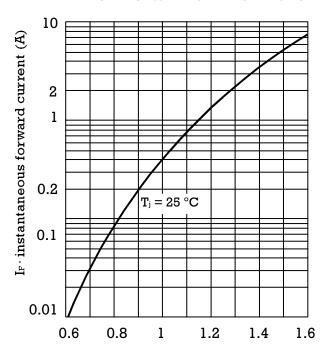
		RGP 10A	RGP 10B	RGP 10D	RGP 10G	RGP 10J	RGP 10K	RGP 10M	RGP 10MT	
$V_{RRM}$	Peak recurrent reverse voltage (V)	50	100	200	400	600	800	1000	1000	
I <sub>F(AV)</sub>	Forward current at Tamb = 55 °C		l A							
$I_{FRM}$	Recurrent peak forward current	10 A								
I <sub>FSM</sub>	8.3 ms. peak forward surge current	30 A								
t <sub>rr</sub>	$\begin{array}{ll} \text{Max. reverse recovery} &  I_{_{\!F}} = 0.5 \text{ A} \\ I_{_{\!R\!R}} = 1 \text{ A} \\ I_{_{\!R\!R}} = 0.25 \text{ A} \end{array}$		15	50 ns		250 ns	500	O ns	300 ns	
$T_{j}$	Operating temperature range	− 65 to + 175 °C								
$T_{ m stg}$	Storage temperature range		- 65 to + 175 °C							
$\rm E_{RSM}$	Maximum non repetitive peak reverse avalanche energy. $I_R = 0.5  \text{A} \; ; \; T_J = 25  ^{\circ}\text{C}$	20 mJ								

### Electrical Characteristics at Tamb = 25 °C

$V_{\scriptscriptstyle F}$	Max. forward voltage drop at $I_F = 1$ A		1.3 V		
$I_R$	$ \text{Max. reverse current at V}_{\text{RRM}}  \text{at } 2 \\ \text{at } 15 \\$	5°C 60°C	5 μ A 200 μ A		
$R_{\text{thj-a}}$	Thermal resistance ( $I = 10 \text{ mm.}$ )	Мах. Тур.	60 °C/W 45 °C/W		

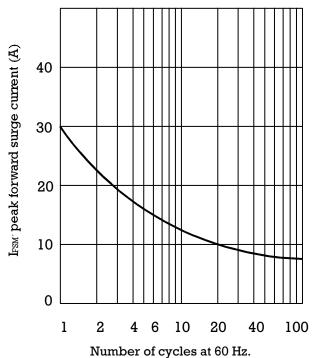
# Rating And Characteristic Curves

#### TYPICAL FORWARD CHARACTERISTIC

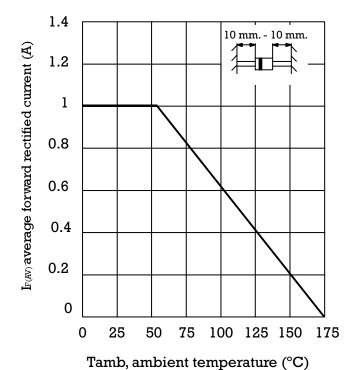


V<sub>F</sub> instantaneous forward voltage (V)

# MAXIMUM NON REPETITIVE PEAK FORWARD SURGE CURRENT



#### FORWARD CURRENT DERATING CURVE



# TYPICAL JUNCTION CAPACITANCE

